



RoHS compliant
1310 nm multi-mode Transceiver (2 km)
2x5, LC Duplex Connector, 3.3 V
155 Mbps ATM/ Fast Ethernet



Features

- RoHS compliant
- Industry standard 2x5 footprint
- LC duplex connector
- Single power supply 3.3 V
- Differential LVPECL inputs and outputs
- Class 1 laser product complies with EN 60825-1

Ordering Information

PART NUMBER	INPUT/OUTPUT	SIGNAL DETECT	VOLTAGE	TEMPERATURE
LM34-A3C-PC-N	DC/DC	LVPECL	3.3 V	0 °C to 70 °C
LM34-A3C-PI-N	DC/DC	LVPECL	3.3 V	-40 °C to 85 °C

Absolute Maximum Ratings

PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTE
Storage Temperature	T_S	-40	85	°C	
Supply Voltage	V_{CC}	-0.5	4.0	V	
Input Voltage	V_{IN}	-0.5	V_{CC}	V	
Soldering Temperature	T_{SOLD}	---	260	°C	10 seconds on leads



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Operating Environment

PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTE
Case Operating Temperature	T_C	0 -40	70 85	°C	
Supply Voltage	V_{CC}	3.1	3.5	V	
Total Supply Current	$I_{CC}(TX+RX)$		250	mA	

Transmitter Electro-optical Characteristics

PARAMETER	SYMBOL	MIN	TYP.	MAX	UNITS	NOTE
Data Rate	B	50	155	200	Mb/s	
Output Optical Power 62.5/125 μ m fiber	P_{out}	-20	---	-14	dBm	Average
Output Optical Power 50/125 μ m fiber		-23.5	---	-14	dBm	Average
Extinction Ratio	ER	10	---	---	dB	
Center Wavelength	λ_C	1261	1310	1360	nm	
Spectral Width (RMS)	$\Delta\lambda$	---	---	20	nm	
Duty Cycle Distortion	DCD			0.6	ns	
Data Dependent Jitter	DDJ			0.6	ns	
Random Jitter	RJ			0.6	ns	
Transmitter Data Input Voltage-High	$V_{IH} - V_{CC}$	-1.1	---	-0.74	V	
Transmitter Data Input Voltage-Low	$V_{IL} - V_{CC}$	-2.0	---	-1.58	V	



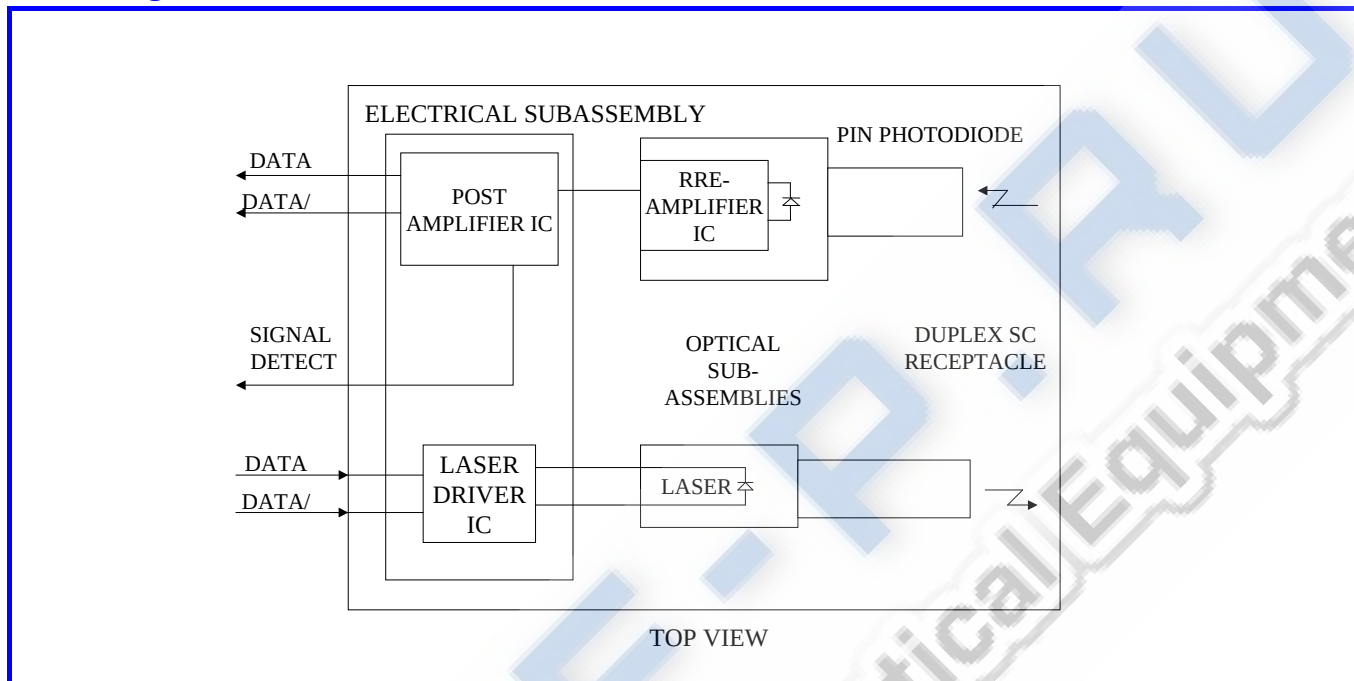
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Receiver Electro-optical Characteristics

PARAMETER	SYMBOL	MIN	TYP.	MAX	UNITS	NOTE
Data Rate	B	50	155	200	Mb/s	
Optical Input Power-maximum	P_{IN}	-8	---	---	dBm	Note 1
Optical Input Power-minimum (Sensitivity)	P_{IN}	---	---	-31	dBm	Note 1
Operating Center Wavelength	λ_C	1260	---	1610	nm	
Signal Detect-Asserted	P_A	---	---	-31	dBm	Average
Signal Detect-Deasserted	P_D	-45	---	---	dBm	Average
Signal Detect-Hysteresis	$P_A - P_D$	0.5	---	---	dB	
Signal Detect Output voltage-High	$V_{OH} - V_{CC}$	-1.1	---	-0.74	V	
Signal Detect Output voltage-Low	$V_{OL} - V_{CC}$	-2.0	---	-1.58	V	
Data Output Rise, Fall Time (10-90%)	$T_{r,f}$	---	---	3	ns	
Data Output Voltage-High	$V_{OH} - V_{CC}$	-1.1	---	-0.74	V	
Data Output Voltage-Low	$V_{OL} - V_{CC}$	-2.0	---	-1.58	V	

Note 1: The input data is at 155.52 Mbps, $2^{23}-1$ PRBS data pattern. The receiver is guaranteed to provide output data with Bit Error Rate (BER) better than or equal to 2.5×10^{-10} .

Block Diagram of Transceiver



Transmitter Section

The transmitter section consists of a 1310 nm laser in an eye safe optical subassembly (OSA) which mates to the fiber cable. The laser OSA is driven by a driver IC which converts differential input LVPECL logic signals into an analog laser driving current.

Receiver Section

The receiver utilizes an InGaAs PIN photodiode mounted together with a trans-impedance preamplifier IC in an OSA. This OSA is connected to a circuit providing post-amplification quantization, and optical signal detection.

Receiver Signal Detect

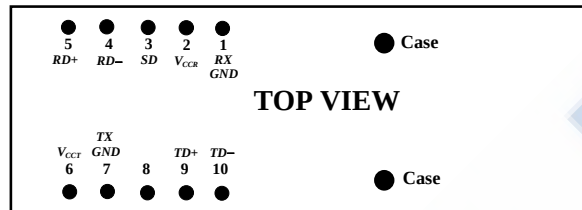
Signal Detect is a basic fiber failure indicator. This is a single-ended LVPECL output. As the input optical power is decreased, Signal Detect will switch from high to low (deassert point) somewhere between sensitivity and the no light input level. As the input optical power is increased from very low levels, Signal Detect will switch back from low to high (assert point).



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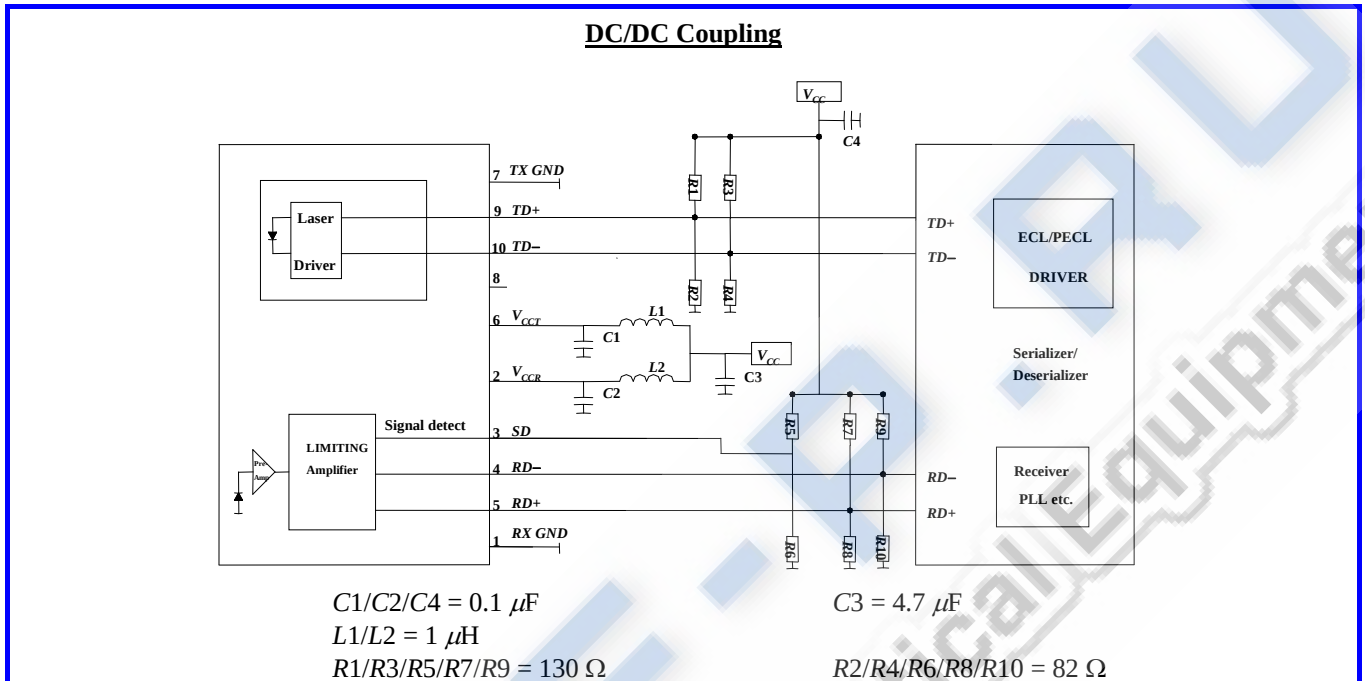
Connection Diagram

Pin-Out



PIN	SYMBOL	DESCRIPTION
1	<i>RX GND</i>	Receiver Signal Ground. Directly connect this pin to the receiver ground plane.
2	<i>VCCR</i>	Receiver Power Supply Provide +3.3 Vdc via the recommended receiver power supply filter circuit. Locate the power supply filter circuit as close as possible to the <i>VCCR</i> pin.
3	<i>SD</i>	Signal Detect. Normal optical input levels to the receiver result in a logic “1” output, <i>V_{OH}</i> , asserted. Low input optical levels to the receiver result in a fault condition indicated by a logic “0” output <i>V_{OL}</i> , deasserted. Signal Detect is a single-ended LVPECL output. <i>SD</i> can be terminated with LVPECL techniques via 50Ω to <i>VCCR</i> – 2 V. Alternatively, <i>SD</i> can be loaded with a 180 Ω resistor to <i>RX GND</i> to conserve electrical power with small compromise to signal quality. If Signal Detect output is not used, leave it open-circuited. This Signal Detect output can be used to drive a LVPECL input on an upstream circuit, such as, Signal Detect input or Loss of Signal-bar.
4	<i>RD–</i>	<i>RD–</i> is an open-emitter output circuit. Terminate this high-speed differential LVPECL output with standard LVPECL techniques at the follow-on device input pin. (See recommended circuit schematic)
5	<i>RD+</i>	<i>RD+</i> is an open-emitter output circuit. Terminate this high-speed differential LVPECL output with standard LVPECL techniques at the follow-on device input pin. (See recommended circuit schematic)
6	<i>VCCR</i>	Transmitter Power Supply. Provide +3.3 Vdc via the recommended transmitter power supply filter circuit. Locate the power supply filter circuit as close as possible to the <i>VCCR</i> pin.
7	<i>TX GND</i>	Transmitter Signal Ground. Directly connect this pin to the transmitter signal ground plane. Directly connect this pin to the transmitter ground plane.
8	<i>TX_{DIS}</i>	Transmitter Disable. Connect this pin to +3.3V TTL logic high “1” to disable transmitter. To enable module connect to TTL logic low “0” or open.
9	<i>TD+</i>	Transmitter Data In. Terminate this high-speed differential LVPECL input with standard LVPECL techniques at the transmitter input pin. (See recommended circuit schematic)
10	<i>TD–</i>	Transmitter Data In-Bar. Terminate this high-speed differential LVPECL input with standard LVPECL techniques at the transmitter input pin. (See recommended circuit schematic)

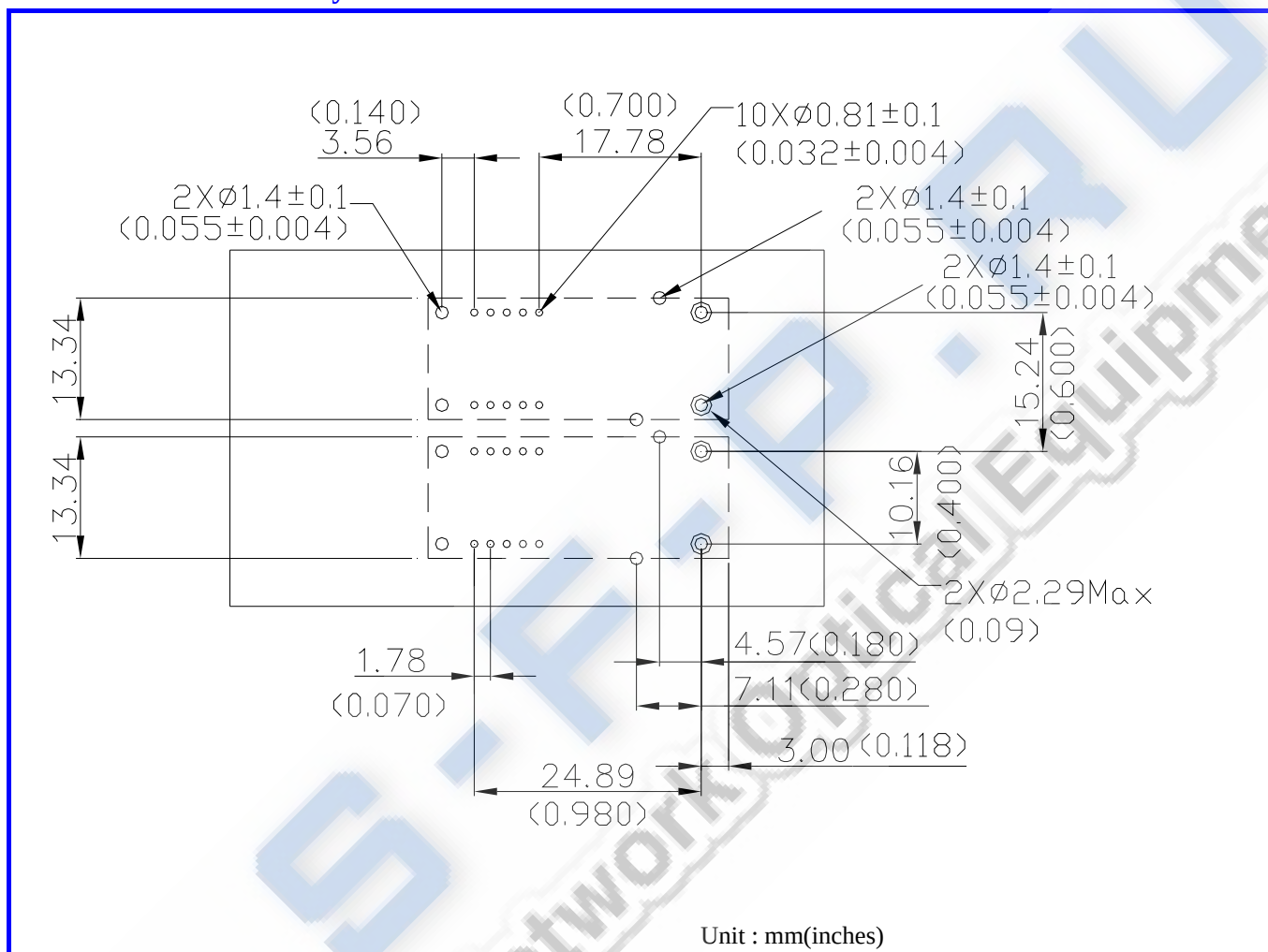
Recommended Circuit Schematic



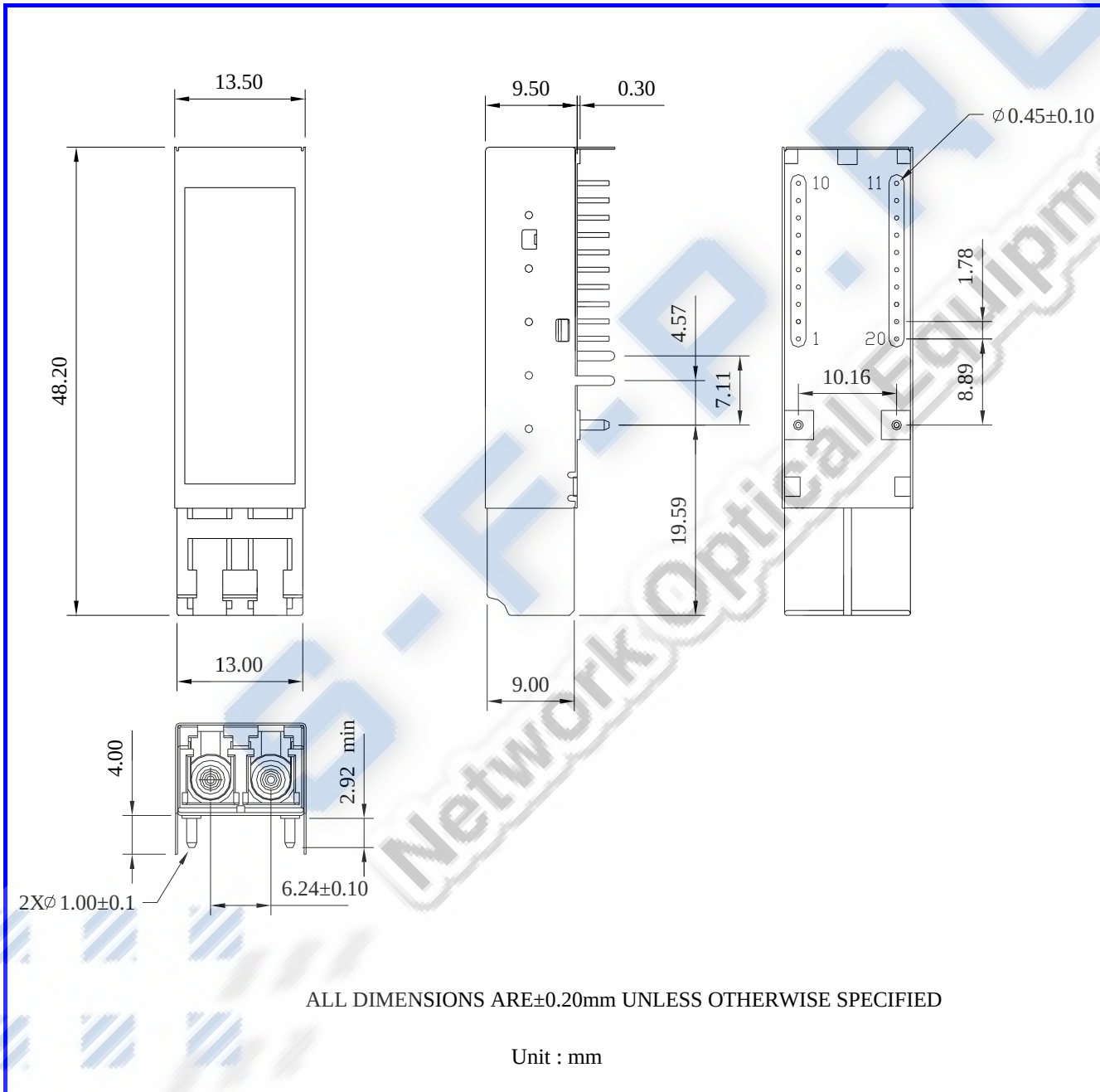
In order to get proper functionality, a recommended circuit is provided in above recommended circuit schematic. When designing the circuit interface, there are a few fundamental guidelines to follow.

- (1) The differential data lines should be treated as 50 Ω Micro strip or strip line transmission lines. This will help to minimize the parasitic inductance and capacitance effects. Locate termination at the received signal end of the transmission line. The length of these lines should be kept short and of equal length.
- (2) For the high speed signal lines, differential signals should be used, not single-ended signals, and these differential signals need to be loaded symmetrically to prevent unbalanced currents which will cause distortion in the signal.
- (3) Multi layer plane PCB is best for distribution of V_{CC} , returning ground currents, forming transmission lines and shielding. Also, it is important to suppress noise from influencing the fiber-optic transceiver performance, especially the receiver circuit.
- (4) A separate proper power supply filter circuits shown in Figure for the transmitter and receiver sections. These filter circuits suppress V_{CC} noise over a broad frequency range, this prevents receiver sensitivity degradation due to V_{CC} noise.
- (5) Surface-mount components are recommended. Use ceramic bypass capacitors for the 0.1 μF capacitors and a surface-mount coil inductor for 1 μH inductor. Ferrite beads can be used to replace the coil inductors when using quieter V_{CC} supplies, but a coil inductor is recommended over a ferrite bead. All power supply components need to be placed physically next to the V_{CC} pins of the receiver and transmitter.
- (6) Use a good, uniform ground plane with a minimum number of holes to provide a low-inductance ground current return for the power supply currents.

Recommended Board Layout Hole Pattern



Drawing Dimensions



Note : All information contained in this document is subject to change without notice.